# TLE 7263E 

Integrated HS-CAN, LIN, LDO and HS Switch
System Basis Chip

## Automotive Power

Never stop thinking.

Integrated HS-CAN, LIN, LDO and HS Switch
TLE 7263E System Basis Chip


## 1 <br> Overview

## Features

- Two Low Drop Voltage Regulators
- Window watchdog
- Standard 16-bit SPI-interface
- Supports $\mu$ Controller Stop Mode
- Sleep Mode $(50 \mu A)$
- $\mathrm{V}_{\mathrm{BAT}}$ Monitoring and fail-safe output
- Overtemperature and short circuit protection


PG-DSO-36-53

- Power on and undervoltage reset generator
- High side switch, 150 mA
- 4 Monitoring / wake-up inputs
- Exposed Pad Package
- AEC Qualified
- Green (RoHS Compliant) product


## HS CAN Transceiver

- CAN data transmission rate up to 1 MBaud
- Low power mode management
- Supports sleep and receive-only modes
- Bus wake-up capability via CAN message
- Bus pins are short circuit proof to ground and battery voltage


## LIN Transceiver

- Single-wire transceiver
- Transmission rate up to 20 kBaud
- Compatible to LIN specification 1.3, 2.0, 2.1 and SAE J2602-2
- Very low current consumption in Sleep Mode
- Short circuit proof to GND and battery

| Type | Package | Marking |
| :--- | :--- | :--- |
| TLE 7263E | PG-DSO-36-53 |  |

## Overview

## Dual-Voltage Regulator

- Low-dropout voltage regulator, dual voltage-supply
- V1, $150 \mathrm{~mA}, 5 \mathrm{~V} \pm 2 \%$ for external devices, e.g. microcontrollers
- V2, $150 \mathrm{~mA}, 5 \mathrm{~V} \pm 2 \%$ for internal CAN module and external devices.


## Description

The TLE 7263E is a monolithic integrated circuit in an enhanced power package. The IC is designed for CAN-LIN gateway applications.
To support these applications the TLE 7263E covers smart power functions such as HSCAN transceiver and LIN transceiver for data transmission, dual low dropout voltage regulator (LDO) for external 5 V supply, and high-side switch as well as a 16-bit SPI (serial peripheral interface) to control and monitor the IC. There is also a window watchdog circuit with a reset feature, a fail-safe output, a voltage sensing input and a undervoltage reset feature implemented.
The device offer low power modes in order to support modules directly connected to the battery (KL. 30). A wake-up from the low power mode is possible via a message on the bus or via the bi level sensitive monitoring/wake-up inputs. The integrated High-Side switch can also be used to periodically supply an external wake-up circuitry in the low power mode, by choosing a special function. The integrated bus transceivers offer a receive-only mode for software diagnosis functions.

The IC is designed to withstand the severe conditions of automotive applications.

TLE 7263E

Pin Configuration

## 2 Pin Configuration



Figure 1 Pin Configuration (top view)

TLE 7263E

Pin Configuration

## Table 1 Pin Definitions and Functions

| Pin | Symbol | Function |
| :---: | :---: | :---: |
| $\begin{array}{\|l\|} \hline 9 \\ 10 \\ 11 \\ 12 \end{array}$ | MON1, MON2, MON3, MON4 | Monitoring / Wake-Up Inputs; bi level sensitive inputs used to monitor signals coming from, for example, an external switch panel; also used as wake-up input during cyclic sensing in low power modes (MON4 is exempted from "cyclic sense" as this input is permanently active) |
| 8 | $V_{\text {S }}$ | Power Supply Input; block to GND directly at the IC with ceramic capacitor; (ferrite recommended for better EMC behavior) |
| 15 | $V_{\mathrm{CC} 1}$ | Voltage Regulator Output (V1); 5 V supply; to stabilize block to GND with an external capacitor $C_{\mathrm{Q}} \geq 10 \mu \mathrm{~F}$, $\mathrm{ESR}<6 \Omega$ |
| 16 | $V_{\mathrm{CC} 2}$ | Voltage Regulator Output (V2); 5 V supply; to stabilize block to GND with an external capacitor $C_{\mathrm{Q}} \geq 10 \mu \mathrm{~F}$, $\mathrm{ESR}<6 \Omega$ |
| 32 | WKO | Wake-Up Event Output; indicates wake up via monitoring inputs, CAN or LIN during Sleep or Stop Mode; active low; wake up sets device to Standby Mode |
| 33 | FSO | Fail Safe Output; to supervise and control critical applications, high when watchdog is correctly served, low at any reset condition; active low |
| 26 | RO | Reset Output; open drain output, integrated pull-up, active low |
| 13 | SI | Sense Comparator Input; for monitoring of external voltages, to program the detection level connect external voltage divider |
| 17 | INT | Interrupt Output; output to monitor sense comparator input condition; input for enabling the Flash Programming Mode (voltage to be applied $>7 \mathrm{~V}$ ) |
| 5 | MTS | Master Termination Switch; output used to turn-on the termination/pull-up resistor of a LIN master |
| 34 | RxD ${ }_{\text {LIN }}$ | LIN Transceiver Data Output; according to the ISO 9141 and LIN specification 1.3 and 2.0; push-pull output; LOW in dominant state |
| 35 | TxD ${ }_{\text {LIN }}$ | LIN Transceiver Data Input; according to ISO 9141 and LIN specification 1.3 and 2.0 |

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Pin Configuration
Table 1 Pin Definitions and Functions (cont'd)

| Pin | Symbol | Function |
| :---: | :---: | :---: |
| 4 | LIN | LIN Bus; Bus Line for the LIN interface, according to ISO 9141 and LIN specification 1.3 and 2.0 |
| 29 | DI ${ }_{\text {SPI }}$ | SPI Data Input; receives serial data from the control device; serial data transmitted to DI is a 16-bit control word with the Least Significant Bit (LSB) transferred first: the input has a pull-down and requires CMOS logic level inputs; DI will accept data on the falling edge of CLK-signal |
| 28 | $\mathrm{DO}_{\text {SPI }}$ | SPI Data Output; this tri-state output transfers diagnosis data to the control device; the output will remain 3-stated unless the device is selected by a low on Chip-Select-Not (CSN) |
| 30 | $\mathrm{CLK}_{\text {SPI }}$ | SPI Clock Input; clock input for shift register; CLK has an internal pull-down and requires CMOS logic level inputs |
| 31 | $\mathrm{CSN}_{\text {SPI }}$ | SPI Chip Select Not Input; CSN is an active low input; serial communication is enabled by pulling the CSN terminal low; CSN input should only be transitioned when CLK is low; CSN has an internal pull-up and requires CMOS logic level inputs |
| 7 | OUTHS | High Side Switch Output; controlled via SPI, in SBC Sleep Mode controlled by internal cyclic sense function when selected |
| 24 | TxD ${ }_{\text {CAN }}$ | CAN Transmit Data Input; integrated pull-up |
| 25 | RxD ${ }_{\text {CAN }}$ | CAN Receive Data Output |
| 21 | SPLIT | CAN Termination Output; to support the recessive voltage level of the bus lines |
| 20 | CANH | CAN High Line Output |
| 22 | CANL | CAN Low Line Input |
| 27 | STS | Send-to-Sleep; to switch the SBC back into low current mode during cyclic wake |
| $\begin{aligned} & 1,2 \\ & 6,14 \\ & 18,19 \\ & 23,36 \end{aligned}$ | GND | Ground |
| 3 | NC | Not Connected Internally; leave open or connect to GND |
| EP | EP | Exposed Pad; internally connected to GND; connect to GND on board |

## 3 Block Diagram



Figure 2 Functional Block Diagram

TLE 7263E

Features

## 4 <br> Features

The TLE 7263E incorporates a lot of features, that are listed in Table 2 below. A short description of the features is given in "Operation Modes" on Page 9.
Table 2 Truth Table of the TLE 7263E

| Feature |  | SBC <br> Standby <br> Mode | SBC Stop Mode | SBC <br> Sleep <br> Mode | CAN <br> RxD-only <br> Mode |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\mathrm{CC}}, \mathrm{V} 1,5 \mathrm{~V}$ | ON | ON | ON | OFF | ON |
| $\mathrm{V}_{\mathrm{Cc}}, \mathrm{V} 2,5 \mathrm{~V}$ | ON | ON/OFF | ON/OFF | OFF ${ }^{1)}$ | ON |
| Reset RO | ON | ON | ON | OFF | ON |
| Window Watchdog | ON | ON | ON/OFF | OFF/[ON] | ON |
| Fail Safe Output | ON | ON | ON | OFF | ON |
| Sense input | ON | ON | ON | OFF | ON |
| Monitoring pins | ON | ON | ON | ON | ON |
| HS-switch | ON | ON | ON | OFF | ON |
| HS-cyclic-sense | OFF | OFF | ON | ON | OFF |
| 16-bit SPI | ON | ON | ON | OFF | ON |
| CAN/LIN wake-up via bus message | OFF/"Sleep" | ON | ON | ON | OFF |
| CAN Transmit | ON/"Sleep" | OFF | OFF | OFF | OFF |
| CAN Receive | ON/"Sleep" | OFF | OFF | OFF | ON |
| LIN Transmit | ON/"Sleep" | OFF | OFF | OFF | ON |
| LIN Receive | ON/"Sleep" | OFF | OFF | OFF | ON |
| $\mathrm{RxD}_{\text {LIN }}$ | L/H | active low wake-up interrupt | active low wake-up interrupt | Iow | L/H |
| $\mathrm{RxD}_{\text {CAN }}$ | L/H | active low wake-up interrupt | active low wake-up interrupt | low | L/H |
| INT output | active low early warning | active low early warning | active low early warning | low | active low early warning |
| WKO output | OFF | active low wake-up | active low wake-up | Iow | OFF |

[^0]
## Features

### 4.1 Operation Modes

This System Basis Chip (SBC) offers five main operation modes that are controlled via three mode select bits MS1, MS2 and MS3 within the SPI: SBC Active, Standby, Sleep and Stop mode, as well as CAN Receive-Only mode. After powering-up the SBC, it starts-up in SBC Standby Mode, waiting for the microcontroller to finish its startup and initialization sequences. From this transition mode the SBC can be switched via SPI command into the desired operating mode (The device should not be switched directly from Standby Mode to Sleep or Stop Mode). All modes are selected via SPI bits or certain operation conditions, e.g. external wake-up events.
The SBC Active Mode, that is used in order to transmit and receive CAN and LIN messages, supports two additional sub-modes, "CAN Sleep" and "LIN Sleep". During these sub-modes the SBC remains its voltage regulators running in order to supply external devices. Also, the line termination of the "sleeping" bus transceiver is turned-off respectively.
During SBC Sleep Mode, the lowest power consumption is achieved, by having its main voltage regulator switched-off. As the microcontroller can not be supplied, the integrated window watchdog might be disabled in Sleep Mode via SPI bit. However, it can be turned-on for periodically waking-up the system, e.g. ECU, by generating a reset.
In case an external microcontroller needs to be supplied with its quiescent current, the SBC Stop Mode can be chosen. In this mode the main voltage regulator remains active. Optionally, the second voltage regulator can be turned-on or off via the SPI prior to entering one of the respective power saving modes. The integrated window watchdog remains active until the microcontroller enters its power saving mode ("Stop Mode"). This power saving mode is assumed to be reached once the current consumption is below a certain threshold (see Watchdog current threshold, Table and "Window Watchdog, Reset" on Page 26).
In both low power modes the internal bus transceivers, including the line termination, are turned off while the wake-up capabilities via bus message or monitoring pins are still active. The SBC offers Sleep and Stop Mode in conjunction with or without the Cyclic Sense/Wake feature. If the Cyclic Sense/Wake feature is selected, two possible states can be entered during Sleep/Stop Mode: HS-On and HS-Off (see text and respective state diagram).
The Cyclic Sense feature can be used to supply an external wake-up circuitry periodically, and is entered upon activation via SPI command. In cyclic sense HS-On state, the High-Side switch is activated for a certain "on-time" and provides supply voltage at its OUTHS pin. Within this on-time the SBC starts sampling of the monitoring/wake-up lines. On-time as well as time period are programmable via the SPI control word. A wake-up at the monitoring / wake-up pins during the on-time as well as a message at the CAN or LIN bus lines automatically sets the TLE 7263E into SBC Standby mode, and turns-on the main voltage regulator $V_{\mathrm{CC} 1}$. The digital $\mathrm{RxD}_{\mathrm{CAN}} / \mathrm{RxD}_{\mathrm{LIN}}$ lines, that are monitored by the microcontroller during power saving, are pulled low with
respect to the wake-up source (CAN or LIN). Furthermore, the wake-up source is indicated within the SPI status word. Additionally, the wake-up capabilities of the monitoring / wake-up pins can be configured via SPI.
If Cyclic Wake is entered upon SPI command, the High-Side switch is turned-on immediately (HS-On state), providing supply voltage at the OUTHS pin. Once the HSOn state is entered, a transition to the HS-Off state can be triggered by a pulse with a minimum width at the STS pin (see STS pulse width, Table ). The microcontroller fully controls the signal level at the STS pin, and this way determines the duration of the HSOn state. As of now the HS-Off state is automatically terminated according to the Cyclic Wake period selected via SPI, or by a CAN or LIN message.


Figure 3 Functional Overview "SBC Operation Modes"

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Features

### 4.2 SBC Sleep Mode without Cyclic Sense

In order to reduce the current consumption to a minimum, the SBC offers a Sleep Mode without Cyclic Sense (see Figure 4). This mode is entered via SPI command, and turnsoff the integrated bus transceivers and respective termination, main voltage regulator as well as the High-Side switch. Upon a voltage level change at the monitoring/wake-up pins or by a CAN or LIN message the SBC Sleep Mode will be terminated and the SBC Standby Mode will automatically be entered.


Figure 4 State Diagram "SBC Sleep Mode without Cyclic Sense"
Note: To switch into Low Power Mode from Standby Mode the device should be switched into Normal Mode first. This is required to reset the CAN and LIN transceiver to ensure correct wakeup as well as to ensure the correct function of the RO pin when going to Sleep Mode. The time the device is in Normal Mode before going to Low Power Mode should be long enough that the Vcc2 is up. This can be released by a wait time or by reading the status of Vcc2 via SPI (bit13).

### 4.3 SBC Sleep Mode with Cyclic Sense

In order to reduce the current consumption to a minimum, but still supply a wake-up circuit periodically, the SBC offers a Sleep Mode with Cyclic Sense (see Figure 5). This mode is entered via SPI command, and turns-off the integrated bus transceivers and respective termination, as well as the main voltage regulator. The High-Side switch is turned-on according to the SPI timings setting for cyclic sense, as there is the cyclic sense period and the on-time. Upon a voltage level change at the monitoring/wake-up pins or by a CAN or LIN message the SBC Sleep Mode will be terminated and the SBC Standby Mode will automatically be entered. The respective RxD pin of the transceiver that generated the wake-up will be pulled low.


Figure 5 State Diagram "SBC Sleep Mode with Cyclic Sense"

### 4.4 SBC Sleep Mode with Cyclic Wake

The SBC Sleep Mode has the advantage of reducing the current consumption to a minimum. During this mode the integrated voltage regulator for external supply is turned off. In case the connected microcontroller needs to get activated periodically, the Cyclic Wake feature in combination with the SBC Sleep Mode can be activated (see Figure 6).


Figure 6 State Diagram "SBC Sleep Mode with Cyclic Wake"

### 4.5 SBC Stop Mode without Cyclic Sense

The SBC Stop Mode has the advantage of reducing the current consumption to a minimum, while supplying the microcontroller with its quiescent current during its power saving mode ("Stop"). This mode is entered via SPI command, and turns-off the integrated bus transceivers and respective termination, but the main voltage regulator remains active.
A voltage level change at the monitoring / wake-up pins will, in contrast to the behavior in Sleep Mode, generate a pulse at the WKO pin that is monitored by the microcontroller, e.g. at an external interrupt input. In case the wake-up event was a CAN or LIN message, the respective RxD pin will be pulled low. (The microcontroller itself has to take care of switching SBC modes after a wake-up event notification (see Figure 7).)


Figure 7 State Diagram "SBC Stop Mode without Cyclic Sense"

### 4.6 SBC Stop Mode with Cyclic Sense

The SBC Stop Mode has the advantage of reducing the current consumption to a minimum, while supplying the microcontroller with its quiescent current during its power saving mode ("Stop"). This mode is entered via SPI command, and turns-off the integrated bus transceivers and respective termination, but the main voltage regulator remains active. The High-Side switch is turned-on according to the SPI timings setting for cyclic sense, as there is the cyclic sense period and the on-time. A voltage level change at the monitoring/wake-up pins will, in contrast to the behavior in Sleep Mode, generate a pulse at the WKO pin that is monitored by the microcontroller, e.g. at an external interrupt input. In case the wake-up event was a CAN or LIN message, the respective RxD pin will be pulled low. (The microcontroller itself has to take care of switching SBC modes after a wake-up event notification (see Figure 8).)


Figure 8 State Diagram "SBC Stop Mode with Cyclic Sense"

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Features

### 4.7 SBC Stop Mode with Cyclic Wake

The SBC Stop Mode has the advantage of reducing the current consumption to a minimum, while supplying the microcontroller with its quiescent current during its power saving mode ("Stop"). This mode is entered via SPI command, and turns-off the integrated bus transceivers and respective termination, but the main voltage regulator remains active. In contrast to Cyclic Sense the HS-On state is entered once Cyclic Wake is selected, immediately providing supply voltage at the OUTHS pin. The microcontroller determines the duration of the HS-On state via the STS input pin (see Figure 9). Further transitions from that HS-Off into the HS-On state are done by the selected cyclic wake period or by a bus message. The microcontroller is notified by the WKO (Wake-Up Output) that the HS-On state has been entered. Further notification is done in the same way as for Cyclic Sense in Stop Mode.


Figure 9 State Diagram "SBC Stop Mode with Cyclic Wake"

## Features

## Continuous Timer Mode (CTM) for "Cyclic Wake Timer"

Upon start of the "cyclic wake timer" in Cyclic Wake Mode the operating mode might be changed to "SBC Active Mode" by the microcontroller, e.g. in order to transmit data via the CAN or LIN transceiver. In this case the timer continues running with the selected period started in Cyclic Wake Mode. This behavior guarantees the periodic generation of a wake-up signal at the WKO pin, even in case of a mode switch. However, this provides that the time spent in SBC Active Mode is not exceeding the selected period.
Should a time-out (end of selected period) occur in SBC Active Mode before the Cyclic Wake Mode is re-entered, the SBC will generate an interrupt signal at its WKO pin if the CTM feature is enabled via the respective SPI bit (see Figure 11).
When the CTM feature is set in the SPI, a wake-up event at the CAN bus in "SBC Active CAN Sleep" mode or at the LIN bus in the "SBC Active LIN Sleep" mode results in switching WKO "low" in addition to switching the RxD to "low".

### 4.8 Dual Low Dropout Voltage Regulator

The dual low dropout voltage regulator integrated in the TLE 7263E is able to drive external as well as internal loads, e.g. CAN-circuit supplied via $V_{\mathrm{CC} 2}$, even in case of a bus short circuit. Its output voltage tolerance is better than $\pm 2 \%$. The maximum output current for external loads is limited to $150 \mathrm{~mA}\left(V_{\mathrm{CC} 1}\right)$, e.g. for microcontroller supply, and $150 \mathrm{~mA}\left(V_{\mathrm{CC} 2}\right)$ for internal CAN module and, e.g. for external sensor supply. The two voltage regulator outputs are protected against overload and overtemperature. The thermal pre-warning flag might be used by the microcontroller to reduce the power dissipation of the TLE 7263E by switching off functions of minor priority until the temperature threshold of the thermal shutdown is reached.
An external reverse current protection is required at the pin $V_{\mathrm{S}}$ to prevent the output capacitor from being discharged by negative transients or low input voltage.
A capacitor of $10 \mu \mathrm{~F}$ at the supply voltage input $V_{S}$ buffers the input voltage. In combination with the required reverse polarity diode this prevents the device from detecting power down conditions in case of negative transients on the supply line. Stability of the output voltage is guaranteed for output capacitors $C_{\mathrm{Q}} \geq 100 \mathrm{nF}$, nevertheless it is recommended to use capacitors $C_{Q} \geq 10 \mu \mathrm{~F}$ to buffer the output voltage and therefore improve the reset behavior at input voltage transients.

### 4.9 CAN Transceiver

The TLE 7263E is optimized for high speed data transmission up to 1 MBaud in automotive applications and is compatible to the ISO 11898 standard. It works as an interface between the CAN protocol controller and the physical bus lines.

This HS-CAN module also supports extended bus error detection via a general error flag as well as individual notification flags, e.g. temperature shutdown and TxD time-out flag, within the SPI.

To reduce EMI the dynamic slopes of the CANL and CANH signals both are limited and symmetric. This allows the use of an unshielded twisted or parallel pair of wires for the bus.
Furthermore there is implemented a time-out feature to prevent the bus from being blocked by a permanently dominant TxD input signal. Both, the CANL and CANH output stage are automatically disabled after the delay time $t_{\mathrm{TxD}}$.
In order to protect the transceiver output stages from being damaged by shorts on the bus lines, current limiting circuits are integrated. The CANL and CANH output stage respectively are protected by an additional temperature sensor, that disables them as soon as the junction temperature exceeds the maximum value. During the temperature shut-down condition of the CAN output stages receiving messages from the bus lines is still possible.

Wake-Up Indication: A bus wake-up via a CAN message (minimum dominant time $t>t_{\text {wu }}$ ) from low power mode sets the RxD pin and the WKO pin to low. In addition, the $\mathrm{V}_{\mathrm{cc} 2}$, which supplies the CAN output stage is switched ON.The CAN transceiver has to be enabled to reset the wake-up capability after a bus wake event and after power-up.

Bus Failure Flaq: signalizes a bus line short circuit condition to $G N D, V_{S}$ or $V_{C C x}$ via SPI bit 11 in the SPI Output Data "CAN Bus Failure".
Remarks: Flag is set after four consecutive recessive to dominant cycles on pin TxD when trying to drive the bus dominant. The bus failure flag is cleared upon 4 recessive to dominant edges at TxD without failure condition.
Local Failure Flag: signalizes the local failure conditions listed in the text below via SPI bit 10 in the SPI Output Data "CAN Local Failure".
Remark: Flag is cleared upon dominant level at RxD while TxD is recessive.
General: release of the transmitter stage only after transition into CAN RxD Only mode and transition back into SBC Active Mode.

## TxD Dominant Failure Detection

At permanent dominant signal for $t>t_{T \times D}$ at $T x D$ the local failure flag is set and the transmitter stage is turned off.
Remarks: none

Features

## RxD Permanent Recessive Clamping

Internal RxD signal does not match signal at RxD pin because the RxD pin is pulled to HIGH (permanent HIGH). This results in setting the local failure flag and disabling of the receiver stage
Remark: the flag is cleared when RxD signal gets dominant.

## TxD to RxD Short Circuit

Caused by a short circuit between RxD and TxD. The local failure flag is set and the transmitter stage is disabled.

Remark: the flag is cleared once the short circuit condition is removed.

## Bus Dominant Clamping

At a permanent dominant signal at the CAN bus for $t>t_{B U S}$ the local failure flag is set.
Remark: none

## Over Temperature Detection

Once the maximum junction temperature at the driving stages exceeded, the local failure flag is set and the transmitter stage is disabled.
Remark: the flag is cleared once RxD gets dominant. Bus only released after the next dominant bit in TxD.

## Split Circuit

The split circuitry is activated during SBC Active and RxD Only Mode and deactivated (SPLIT pin high omic) during SBC Sleep, Stop and Standby Mode. The SPLIT pin is used to stabilize the recessive common mode signal in SBC Active Mode and RxD Only mode. This is realized with a stabilized voltage of $0.5 \mathrm{~V}_{\mathrm{CC} 2}$ at the SPLIT pin.

A correct application of the SPLIT pin is shown in Figure 10. The split termination for the left and right node is realized with two 60 Ohm resistances and one 10 nF capacitor. The center node in this example is a stub node and the recommended value for the split resistances is 1.5 kOhm .


Figure 10 Application of the SPLIT pin for normal nodes and one stub node

### 4.10 LIN Transceiver

The TLE 7263E offers a transceiver, which is compatible to ISO 9141 and LIN specification 2.0. For fail safe reasons the transceiver already has a pull-up resistor of $30 \mathrm{k} \Omega$ implemented. In order to achieve the required timing for the dominant to recessive transition of the bus signal an additional external termination resistor of $1 \mathrm{k} \Omega$ is required, when the LIN node is used as a master. This termination resistor will automatically be turned off via the "Master Termination Switch" pin (MTS) once the LIN module enters LIN Sleep Mode or when the SBC enters Sleep Mode. The transceiver is protected against short to battery and short to GND.
For LIN automotive applications in the United States a dedicated mode by the name "Low Slope Mode" can be used. This mode limits the maximum data transmission rate to 10.4 kBaud by switching to a different slew rate. Operating with the default slew rate at up to 20 kBaud may cause interferences with the AM radio band.
A bus wake-up via a LIN message (minimum dominant time $t>t_{\text {wake }}$ ) from low power mode sets the RxD pin and the WKO pin to low. in addition the MTS is switched ON. The LIN transceiver has to be enabled to reset the wake-up capability after a bus wake event and after power-up.
In case of a "TxD dominant time out failure" or a "transmitter thermal shutdown" the SPI bit 9 is set. After a SPI read-out this bit will be reset unless one of the failure conditions is still present.
Note: In case of a short to GND on the LIN bus a RxD dominant signal is generated by the SBC. In the case that RxD is dominant the device can not go into low power mode from normal mode.

### 4.11 SPI (Serial Peripheral Interface)

The 16-bit wide Programming or Input Word (see Table 3) is read in via the data input DI, which is synchronized with the clock input CLK supplied by the $\mu \mathrm{C}$. The Diagnosis or Output Word appears synchronously at the data output DO (see Figure 10).
The transmission cycle begins when the chip is selected by the Chip Select Not input CSN ("low" active). After the CSN input returns from L to H, the word that has been read in becomes the new control word. The DO output switches to tristate status at this point, thereby releasing the DO bus for other usage.
The state of DI is shifted into the input register with every falling edge on CLK. The state of DO is shifted out of the output register after every rising edge on CLK. The number of received input clocks is supervised by a modulo-16 operation and the Input / Control Word is discarded in case of a mismatch. This error is flagged by the WKO set to "low" and in the following SPI output by a "high" at the data output (DO pin) before the first rising edge of the clock is received.


Figure 11 16-Bit SPI Input Data / Control Word

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Features
Table 3 SPI Input Data Bits

| IBIT | Input Data |
| :--- | :--- |
| $0 \ldots 2$ | Mode Selection |
| $3 \ldots 4$ | Configuration Selection (determine meaning of "Configuration Setting Bits") |
| $5 \ldots 13$ | Configuration Settings (meaning based on "Configuration Selection Bits") |
| 14 | $V_{\mathrm{CC2}}$ Activation (power saving modes only) |
| 15 | Window Watchdog "on"/"off" (power saving modes only) |

Table 4 Mode Selection Bits

| MS2 | MS1 | MS0 | Mode Selection: SBC Mode |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | "reserved" / not valid |
| 0 | 0 | 1 | SBC Active Mode: "CAN Sleep" |
| 0 | 1 | 0 | SBC Active Mode: "LIN Sleep" |
| 0 | 1 | 1 | SBC Active Mode (CAN \& LIN "on") |
| 1 | 0 | 0 | SBC Sleep (CAN, LIN \& VReg "off") |
| 1 | 0 | 1 | SBC Active mode : CAN Transceiver: RxD-Only |
| 1 | 1 | 0 | SBC Active mode : LIN Transceiver: RxD-Only |
| 1 | 1 | 1 | SBC Stop Mode (CAN \& LIN "off") |

Table 5 Configuration Selection Bits

| CS1 | CS0 | Configuration Selection |
| :--- | :--- | :--- |
| 0 | 0 | General Configuration |
| 0 | 1 | Integrated Switch Configuration |
| 1 | 0 | Cyclic Sense / Wake Configuration |
| 1 | 1 | Window Watchdog Configuration |

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Features
Table 6 General \& Integrated Switch Configuration

| Pos. | General Configuration ${ }^{1)}$ | Integrated Switch Configuration") |
| :--- | :--- | :--- |
| 5 | Reset Threshold (see Table : "Reset <br> Generator", "0" = $V_{\mathrm{RT1}}$ / <br> "1" $=V_{\mathrm{RT} 2}$ ) | OUTHS "on" / "off" |
| 6 | Reset Delay ("0" = 5 ms / "1" $=0.5 \mathrm{~ms})$ | "reserved" / not used |
| 7 | LIN "Low Slope Mode" (10.4 kBaud) | "reserved" / not used |
| 8 | MON1 Input Wake-Up Capability | "reserved" / not used |
| 9 | MON2 Input Wake-Up Capability | "reserved" / not used |
| 10 | MON3 Input Wake-Up Capability | "reserved" / not used |
| 11 | MON4 Input Wake-Up Capability | "reserved" / not used |
| 12 | Sense Input (SI) "on" / "off" | "reserved" / not used |
| 13 | "reserved" / not used | "reserved" / not used |

1) $" 1 "=O N$ (enable), " $0 "=$ OFF (disable)
2) " 1 " = ON, " 0 " = OFF

Table $7 \quad$ Cyclic Sense / Wake \& Window Watchdog Period Settings ${ }^{1)}$

| Pos. | Cyclic Sense / Wake Configuration | Window Watchdog Configuration |
| :--- | :--- | :--- |
| 5 | Cyclic Period Bit 0 (T0) | Watchdog Period Bit 0 (T0) |
| 6 | Cyclic Period Bit 1 (T1) | Watchdog Period Bit 1 (T1) |
| 7 | Cyclic Period Bit 2 (T2) | Watchdog Period Bit 2 (T2) |
| 8 | Cyclic Period Bit 3 (T3) | Watchdog Period Bit 3 (T3) |
| 9 | Cyclic Period Bit 4 (T4) | Watchdog Period Bit 4 (T4) |
| 10 | Cyclic Sense / Wake Selection <br> ("0" = Cyclic Sense / "1" = Cyclic Wake) | Watchdog Period Bit 5 (T5) |
| 11 | OUTHS On-Time Selection <br> ("0" = 500 $\mu \mathrm{S}$ / "1" = 100 $\mu \mathrm{s})$ | "0" [mandatory] |
| 12 | Cyclic Wake Mode only: <br> Select OUTHS "off" via STS / On-Time <br> ("0" = via STS / "1" = via HS On-Time) | "reserved" / not used |
| 13 | Continuous Timer Mode (incl. WKO) <br> ("0" = "off" / "1" = "on" ) | "reserved" / not used |

1) " 1 " = ON, " 0 " = OFF

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Table $8 \quad$ Cyclic Sense / Wake Period Settings

| T4 | T3 | T2 | T1 | T0 | Cyclic Sense or <br> Cyclic Wake Period |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 0 | 0 | Cyclic Sense / Wake "off" |
| 0 | 0 | 0 | 0 | 1 | 16 ms |
| 0 | 0 | 0 | 1 | 0 | 32 ms |
| 0 | 0 | 0 | 1 | 1 | 48 ms |
| 0 | 0 | 1 | 0 | 0 | 64 ms |
| 0 | 0 | 1 | 0 | 1 | 80 ms |
| 0 | 0 | 1 | 1 | 0 | 96 ms |
| $\ldots$ | $\ldots$ | $\ldots$ | $\ldots$ | $\ldots$ | $\ldots \mathrm{~ms}$ |
| 1 | 1 | 1 | 1 | 1 | 496 ms |

Table 9 Window Watchdog Reset Period Settings

| T5 | T4 | T3 | T2 | T1 | T0 | Window Watchdog <br> Reset Period |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 0 | 0 | 0 | "not a valid selection" |
| 0 | 0 | 0 | 0 | 0 | 1 | 16 ms |
| 0 | 0 | 0 | 0 | 1 | 0 | 32 ms |
| 0 | 0 | 0 | 0 | 1 | 1 | 48 ms |
| 0 | 0 | 0 | 1 | 0 | 0 | 64 ms |
| 0 | 0 | 0 | 1 | 0 | 1 | 80 ms |
| 0 | 0 | 0 | 1 | 1 | 0 | 96 ms |
| 0 | $\ldots$ | $\ldots$ | $\ldots$ | $\ldots$ | $\ldots$ | $\ldots \mathrm{~ms}$ |
| 1 | 1 | 1 | 1 | 1 | 1 | 1008 ms |

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Table 10 SPI Output Data

| Pos. | Output Data "active"1) | Output Data "after wake-up"2) |
| :--- | :--- | :--- |
| 0 | $V_{\mathrm{CC} 1}$ Temperature Prewarning | $V_{\mathrm{CC} 1}$ Temperature Prewarning |
| 1 | HS Overcurrent | HS Overcurrent |
| 2 | OUTHS UV / Temp. Shut-Down | OUTHS UV / Temp. Shut-Down |
| 3 | Window Watchdog Reset | Window Watchdog Reset |
| 4 | MON1 Logic Input Level | Wake-Up via MON1 |
| 5 | MON2 Logic Input Level | Wake-Up via MON2 |
| 6 | MON3 Logic Input Level | Wake-Up via MON3 |
| 7 | MON4 Logic Input Level | Wake-Up via MON4 |
| 8 | MONx Initialization Failure | MONx Initialization Failure |
| 9 | LIN Failure | Bus Wake-Up via LIN Msg. |
| 10 | CAN Local Failure | Bus Wake-Up via CAN Msg. |
| 11 | CAN Bus Failure | End of Cyclic Wake Period |
| 12 | $V_{\mathrm{CC} 1}$ Fail (active low) | $V_{\mathrm{CC} 1}$ Fail (active low) |
| 13 | $V_{\mathrm{CC} 2}$ Fail (active low) | $V_{\mathrm{CC} 2}$ Fail (active low) |
| 14 | $V_{\text {INT }}$ Fail (active low) | $V_{\text {INT }}$ Fail (active low) |
| 15 | "reserved" / not used | "reserved" / not used |
| 1 | ON |  |

1) " 1 " = ON (enable), " 0 " = OFF (disable)
2) " 1 " $=O N, " 0$ " = OFF

## Features

### 4.12 Window Watchdog, Reset

When the output voltage $\mathrm{V}_{\mathrm{cc} 1}$ exceeds the reset threshold voltage the reset output RO is switched HIGH after a delay time of typ. 5 ms . This is necessary for a defined start of the microcontroller when the application is switched on. As soon as an undervoltage condition of the output voltage ( $V_{\mathrm{CC} 1}<V_{\mathrm{RT}}$ ) appears, the reset output RO is switched LOW again. The LOW signal is guaranteed down to an output voltage $V_{\mathrm{CC} 1} \geq 1 \mathrm{~V}$. Please refer to Figure 19, Reset Timing Diagram.
After the above described delayed reset (LOW to HIGH transition of RO) the window watchdog circuit is started by opening a long open window of typ. 64 ms . The long open window allows the microcontroller to run its initialization sequences and then to trigger the watchdog via the SPI. A watchdog trigger is detected as a write access to the "window watchdog period bit field" within the SPI control word. In order to distinguish the watchdog from the cyclic sense/wake timing register the "Configuration Select Bits" needs to be set accordingly (see "SPI (Serial Peripheral Interface)" on Page 21). The trigger is accepted when the CSN input becomes HIGH after the transmission of the SPI word.

A correct watchdog trigger results in starting the window watchdog by opening a closed window with a width of $50 \%$ of the selected window watchdog reset period. This period, selected via the window watchdog timing bit field, is in the range between 16 ms and 1008 ms. This closed window is followed by a open window, with a width of $50 \%$ of the selected period. From now on the microcontroller has to service the watchdog by periodically writing to the window watchdog timing bit field. This write access has to meet the open window. A correct watchdog service immediately results in starting the next closed window (see Figure 17 "Watchdog Time-Out Definitions" on Page 54, safe trigger area).
Should the trigger signal not meet the open window a watchdog reset is created by setting the reset output RO low (see Reset delay time $t_{\mathrm{RD}}$ ). Then the watchdog again starts by opening a long open window. In addition, a "window watchdog reset flag" is set within the SPI until the next successful watchdog trigger to monitor a watchdog reset. For fail safe reasons the TLE 7263E is automatically switched in SBC Standby mode if a watchdog trigger failure occurs. This minimizes the power consumption in case of a permanent faulty microcontroller.
In case of a watchdog reset the watchdog immediately starts with a long open window in SBC Standby Mode.
When entering a low power mode the watchdog can be requested to be disabled via an SPI bit (see "SPI (Serial Peripheral Interface)" on Page 21). Upon this request the watchdog is only turned off once the current consumption at $V_{\mathrm{CC} 1}$ falls below the "watchdog current threshold".

## Features

### 4.13 Sense Comparator using Sense Input SI and Interrupt Output INT

The sense comparator (early warning function) compares a voltage defined by the user to an internal reference voltage. Therefore the voltage to be supervised has to be scaled down by a voltage divider in order to compare it to the internal sense threshold $V_{\text {SIth }}$. This feature can be used e.g. to supervise the battery voltage in front of the reverse protection diode. The microcontroller is given a prewarning before an undervoltage reset due to low input voltage occurs. The prewarning is flagged by setting the interrupt output INT low in SBC Active, Standby, and Stop, as well as in CAN Receive - Only Mode, when activated by SPI. In SBC Sleep Mode the sense function is inactive.
Calculation of the voltage divider can be easily done since the sense input current can be neglected. An internal blanking time prevents from false triggering due to line transients. Further improvement is possible by the use of an external ceramic capacitor at the SI pin (see Figure 22, Application Circuit).

### 4.14 $\quad V_{\mathrm{INT}} / V_{\mathrm{CC}}$ Fail Detection via SPI Bit

Should the internal supply voltage become lower than the internal threshold $V_{\text {INT, th }}$ (typ. 2.5 V ) the $V_{\mathrm{INT}}-$ Fail, threshold SPI bit will be reset in order to indicate the low voltage condition. All other SPI settings are also reset by this condition. The $V_{\mathrm{INT}}$ Fail feature can also be used to give an indication when the ECU has been changed and therefore a presetting routine of the microcontroller has to be started.
Further there is also a $V_{C C}$ monitor implemented, where the $V_{C C x}$ is compared to the threshold voltage $V_{\mathrm{CCx}-\text { Fail, threshold }}$ and the $V_{\mathrm{Cc}}$ SPI bit is reset accordingly. This monitoring is only available during voltage-regulator operation.

### 4.15 Monitoring / Wake-Up Inputs MON1/2/3/4 and Wake-Up Output WKO

In addition to a wake-up from SBC Sleep mode via the CAN or LIN bus lines it is also possible to wake-up the TLE 7263E from low power mode via the monitoring/wake-up inputs. These inputs are sensitive to a transition of the voltage level, either from high to low or vice versa. Monitoring is available in Active Mode and indicates the voltage level of the inputs.
A positive or negative voltage edge at MONx in SBC Sleep or Stop Mode results in setting the output WKO low to signal a wake-up. After a wake-up via MONx the first transmission of the SPI diagnosis word in SBC Standby mode indicates the wake-up source. Further SPI status word transmissions show the logic level of the monitoring inputs.
When switching the TLE 7263E into SBC Sleep mode (cyclic sense feature activated) the voltage level at the wake-up inputs is sensed 2 times to initialize the reference voltage. Should this initialization fail (2 samples are unequal) the device is automatically

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set in SBC Standby mode and the initialization error is shown indicated in the SPI status word.

To have a defined level at a floating MONx pin a hold current is implemented. For high level at MONx a pull up current $I_{\text {PU,MON }}$ is driven out of the MONx pin, for low level at MONx a pull down current $I_{P D, M O N}$ is drawn into the MONx pin.

### 4.16 High Side Switch

The high side output OUTHS is able to switch loads up to 150 mA . Its on-resistance is $2.5 \Omega$ typ. @ $25^{\circ} \mathrm{C}$. In SBC Active, Standby, as well as in CAN and LIN Receive-Only mode the high side output is switched on and off, respectively via an SPI input bit.
To supply external wake-up circuits in SBC Sleep Mode the output OUTHS can be periodically switched on by the TLE 7263E itself. How Cyclic Sense works and how it is activated is described in detail in "Operation Modes" on Page 9. Beside the cyclic sense period can the on-time of the OUTHS be programmed to either $500 \mu$ s (default setting) or $100 \mu \mathrm{~S}$ via SPI input bit. OUTHS undervoltage, temperature shutdown, overcurrent as well as a temperature pre-warning is indicated by the SPI status word.
The OUTHS is protected against short circuit and overload. As soon as the undervoltage condition of the supply voltage is met ( $V_{\mathrm{S}}<V_{\text {UVOFF }}$ ), the switch is automatically disabled by the undervoltage lockout circuit. Moreover the switch is automatically disabled when a reset or watchdog reset occurs.

### 4.17 Fail Safe Feature

The output FSO becomes HIGH when the watchdog is correctly serviced by the microcontroller for the fourth time. As soon as either an undervoltage reset or watchdog reset occurs, it is set LOW again. This feature is very useful to control critical applications independent of the microcontroller e.g. to disable the power supply in case of a microcontroller failure.

### 4.18 Send to Sleep Input STS

During Cyclic Wake the STS input is used to switch the SBC back to a low current mode (High-Side switch "off") when the microcontroller has completed its tasks during the periodic wake-up phase, and before it enters its power saving mode ("Stop") again.

### 4.19 Flash Program Mode

For flash programming it is useful to disable the window watchdog function. This can be done by applying a voltage of $V_{\mathrm{INT}}>7.0 \mathrm{~V}$ at pin INT. This is useful e.g. if the flashmemory of the micro has to be programmed and therefore a regular watchdog triggering is not possible.

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Additionally, the transmission rate of the integrated LIN transceiver will be changed to maximal 150 kBaud.

The Sense Comparator using Sense Input and Interrupt Output INT can not be used with Flash Program Mode. The Sense Input feature must be switched off via SPI.

## Hints for Unused Pins

- SI: connect to GND
- OUTHS: leave open
- MON1/2/3/4: connect to GND
- INT / WKO: leave open
- RO / FSO: leave open


## 5 General Product Characteristics

### 5.1 Maximum Ratings

Table 11 Absolute Maximum Ratings

| Parameter | Symbol | Limit Values |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |  |
| Voltages |  |  |  |  |  |
| Supply voltage | $V_{\text {S }}$ | -0.3 | 40 | V | - |
| Regulator output voltage | $\begin{aligned} & V_{\mathrm{CC} 1}, \\ & V_{\mathrm{CC} 2} \\ & \hline \end{aligned}$ | -0.3 | 5.5 | V | - |
| CAN bus voltage (CANH, CANL) | $V_{\text {CANH/L }}$ | -27 | 40 | V | - |
| Input voltage at SPLIT | $V_{\text {SPLIT }}$ | -27 | 40 | V | - |
| Input voltage at MONx and SI | $V_{\text {wK/s }}$ | -27 | 40 | V | - |
| Output voltage at OUTHS and MTS | $V_{0}$ | -27 | $V_{\mathrm{S}}+0.3$ | V | - |
| Logic input voltages (DI, CLK, CSN, STS, TxD) | $V_{1}$ | -0.3 | $V_{\mathrm{CC}}+0.3$ | V | $\begin{aligned} & 0 \mathrm{~V}<V_{\mathrm{s}}<24 \mathrm{~V} \\ & 0 \mathrm{~V}<V_{\mathrm{CC}}<5.5 \mathrm{~V} \end{aligned}$ |
| Logic output voltage (DO, RO, INT, RxD, FSO, WKO) | $V_{\text {DRI,RD }}$ | -0.3 | $V_{\text {CC }}+0.3$ | V | $\begin{aligned} & 0 \mathrm{~V}<V_{\mathrm{S}}<24 \mathrm{~V} \\ & 0 \mathrm{~V}<V_{\mathrm{CC}}<5.5 \mathrm{~V} \end{aligned}$ |
| Input voltage at Pin INT | $V_{\text {INT }}$ | -27 | 40 | V | Sense Input off |
| LIN line bus input voltages | $V_{\text {bus }}$ | -27 | 40 | V | - |

## ESD resistivity

| ESD at RxD pin versus GND | $V_{\text {ESD,RxD }}$ | -2 | 1.5 | $k V$ | $\mathrm{HBM}^{1)}$ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| ESD all other pins. versus GND | $V_{\text {ESD1 }}$ | -2 | 2 | $k V$ | $\mathrm{HBM}^{1)}$ |
| ESD at pin CANH, CANL, <br> SPLIT, LIN, MONx versus GND | $V_{\text {ESD1 }}$ | -6 | 6 | $k V$ | $\mathrm{HBM}^{1)}$ |

## Temperatures

| Junction temperature | $T_{\mathrm{j}}$ | -40 | 150 | ${ }^{\circ} \mathrm{C}$ | - |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Storage temperature | $T_{\text {stg }}$ | -50 | 150 | ${ }^{\circ} \mathrm{C}$ | - |

1) ESD susceptibility HBM according to EIA/JESD 22-A 114B.

Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.

### 5.2 Operating Range

Table 12 Operating Range

| Parameter | Symbol | Limit Values |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |  |
| Supply voltage | $V_{\text {S }}$ | $V_{\text {UV OfF }}$ | 27 | V | After $V_{\mathrm{S}}$ rising above $V_{\text {UV on }}$ |
| Supply voltage | $V_{\mathrm{S}}$ | $V_{\text {UV OFF }}$ | 40 | V | 40 V load dump |
| Supply voltage slew rate | $\mathrm{d} V_{\mathrm{S}} / \mathrm{d} t$ | -0.5 | 5 | $\mathrm{V} / \mathrm{\mu s}$ | - |
| Logic input voltage (DI, CLK, CSN, TxD, STS) | $V_{1}$ | -0.3 | $V_{\mathrm{CC} 1}$ | V | - |
| Output capacitor | $C_{\text {CC1/2 }}$ | 100 | - | nF | ESR < $6 \Omega$ <br> @ $f=10 \mathrm{kHz}$ |
| SPI clock frequency | $f_{\text {clk }}$ | - | 4 | MHz | - |
| Junction temperature | $T_{\text {j }}$ | -40 | 150 | ${ }^{\circ} \mathrm{C}$ | - |

### 5.3 Thermal Resistance

| Parameter | Symbol | Limit Values |  |  |  | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Remarks |  |  |  |  |  |  |
|  |  | Min. | Typ. | Max. |  |  |
| Junction to Case ${ }^{1)}$ | $R_{\mathrm{thjc}}$ | - | 1 | 5 | K/W |  |
| Junction to Ambient ${ }^{1)}$ | $R_{\mathrm{thjA}}$ | - | 25 | - | K/W |  |

1) Not subject to production test, specified by design.
2) According to Jedec JESD51-2,-5,-7 at natural convection on 2 s 2 p board for 1 W . Board: $76.2 \times 114.3 \times 1.5 \mathrm{~mm}^{3}$ with 2 inner copper layers ( $70 \mu \mathrm{~m}$ thick)., with thermal via array under the exposed pad contacted the first inner copper layer

## 6 Electrical Characteristics

## Table 13 Electrical Characteristics

$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Quiescent Current; Pin $V_{\text {S }}$ |  |  |  |  |  |  |
| Current consumption | $I_{\text {Q }}$ | - | 6 | 8 | mA | SBC Active Mode |
|  |  |  | 1.2 | 2 | mA | Active [CAN Sleep] |
|  |  |  | 1.7 | 3 | mA | => LIN dominant; without $R_{L}$ |
|  |  |  | 4 | 6 | mA | Active [LIN Sleep] |
| Current consumption | $I_{\text {Q }}$ | - | 68 | 80 | $\mu \mathrm{A}$ | stand-by mode; $T_{\mathrm{j}}=25^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off" |
|  | $I_{\mathrm{Q}}$ | - | 580 | 900 | $\mu \mathrm{A}$ | stand-by mode; $T_{\mathrm{j}}=25^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off"; after LIN wake-up / power-up |
| Current consumption | $I_{\text {Q }}$ | - | 68 | 80 | $\mu \mathrm{A}$ | stop mode; $T_{\mathrm{j}}=25^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off"; without cyclic sense |
| Current consumption | $I_{\text {Q }}$ | - | 76 | 88 | $\mu \mathrm{A}$ | stop mode; $T_{\mathrm{j}}=85^{\circ} \mathrm{C}$; $V_{\mathrm{CC} 2}$ "off"; without cyclic sense |
| Current consumption | $I_{\mathrm{Q}}$ | - | 49 | 60 | $\mu \mathrm{A}$ | sleep mode; $T_{\mathrm{j}}=25^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off"; without cyclic sense |
| Current consumption | $I_{\mathrm{Q}}$ | - | 53 | 65 | $\mu \mathrm{A}$ | sleep mode; $T_{\mathrm{j}}=85^{\circ} \mathrm{C}$; $V_{\mathrm{CC} 2}$ "off"; without cyclic sense |
| Current consumption | $I_{\mathrm{Q}}$ | - | 220 | 300 | $\mu \mathrm{A}$ | sleep mode, during HS-On phase; $T_{\mathrm{j}}=25^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off" |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  | Min. | Typ. |  |  |
| Current consumption | $I_{\mathrm{Q}}$ | - | 240 | 330 | $\mu \mathrm{~A}$ | sleep mode, during <br> HS-On phase; <br> $T_{\mathrm{j}}=85^{\circ} \mathrm{C} ; V_{\mathrm{CC} 2}$ "off" |

Voltage Regulator; Pin $\boldsymbol{V}_{\mathrm{CC} 1 / 2}$

| Output voltage | $V_{\mathrm{CC} 1 / 2}$ | 4.9 | 5.0 | 5.1 | V | $1 \mathrm{~mA}<I_{\mathrm{CC} 1 / 2}<100 \mathrm{~mA} ;$ <br> $6 \mathrm{~V}<V_{\mathrm{S}}<20 \mathrm{~V}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Line regulation | $\Delta V_{\mathrm{CC} 1 / 2}$ | - | - | 20 | mV | $6 \mathrm{~V}<V_{\mathrm{S}}<16 \mathrm{~V} ;$ <br> $I_{\mathrm{CC}}=1 \mathrm{~mA}$ |
| Load regulation | $\Delta V_{\mathrm{CC} 1 / 2}$ | - | - | 50 | mV | $5 \mathrm{~mA}<I_{\mathrm{CC} 1 / 2}<100 \mathrm{~mA} ;$ <br> $V_{\mathrm{S}}=6 \mathrm{~V}$ |
| Power supply ripple <br> rejection | $P S R R$ | - | 40 | - | dB | $V_{\mathrm{r}}=1 \mathrm{Vpp} ;$ <br> $\mathrm{r}_{\mathrm{r}}=100 \mathrm{~Hz} ;$ <br> specified by design; <br> not subject to <br> production test |
| Output current limit | $I_{\mathrm{CC} 1 / 2 \mathrm{max}}$ | 200 | - | 500 | mA | $V_{\mathrm{CC} 1 / 2}=4.5 \mathrm{~V} ;$ <br> power transistor <br> thermally monitored; <br> 150 mA for external <br> load |
| Drop voltage |  |  |  |  |  |  |

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Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |
| Oscillator |  |  |  |  |  |
| Oscillating frequency | $f_{\mathrm{OSC}}$ | - | 256 | - | kHz | - |
| Internal cycling time <br> $\left(1 / 128 \times f_{\mathrm{OSC}}\right)$ | $t_{\mathrm{CYL}}$ | 400 | 500 | 600 | $\mu \mathrm{~S}$ | - |

Reset Generator; Pin RO

| Reset threshold voltage | $V_{\text {RT1 }}$ | 4.5 | 4.65 | 4.8 | V | default SPI setting |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{\text {RT2 }}$ | 3.2 | 3.35 | 3.5 | V | SPI option; $V_{\text {S }} \geq 4 \mathrm{~V}$ |
| Reset threshold hysteresis | $V_{\text {RT,hys }}$ | - | 100 | - | mV | - |
| Reset low output voltage | $V_{\mathrm{RO}}$ | - | 0.2 | 0.4 | V | $\begin{aligned} & \hline I_{\mathrm{RESET}}=1 \mathrm{~mA} \text { for } \\ & V_{\mathrm{CC} 1}=V_{\mathrm{RT} 1 / 2} ; \\ & I_{\mathrm{RESET}}=200 \mu \mathrm{~A} \text { for } \\ & V_{\mathrm{RT} 1 / 2}>V_{\mathrm{CC}} 1 \geq 1 \mathrm{~V} \\ & \hline \end{aligned}$ |
| Reset high output voltage | $V_{\mathrm{Ro}}$ | $\begin{aligned} & 0.7 \mathrm{x} \\ & V_{\mathrm{CC} 1} \end{aligned}$ | - | $\begin{array}{\|l\|} \hline V_{\mathrm{cC1}} \\ +0.1 \end{array}$ | V | - |
| Reset pull-up current | $I_{\text {RO }}$ | 20 | 150 | 500 | $\mu \mathrm{A}$ | $V_{\mathrm{RO}}=0 \mathrm{~V}$ |
| Reset reaction time | $t_{\text {RR }}$ | 4 | 10 | 26 | $\mu \mathrm{S}$ | $\begin{aligned} & V_{\mathrm{CC} 1}<V_{\mathrm{RT} 1 / 2} \\ & \text { to } \mathrm{RO}=\mathrm{L} \end{aligned}$ |
| Reset delay time | $t_{\text {RD1 }}$ | 4.0 | 5.0 | 6.0 | ms | default SPI setting; after Power-On-Reset |
|  | $t_{\text {RD2 }}$ | 0.4 | 0.5 | 0.6 | ms | SPI setting option |

Fail Safe Output; Pin FSO

| Watchdog edge count <br> difference to set HIGH | $n_{\mathrm{FS}}$ | - | 4 | - | - | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Fail Safe low output <br> voltage | $V_{\mathrm{FS}}$ | - | 0.2 | 0.4 | V | $I_{\mathrm{FSO}}=1 \mathrm{~mA}$ for <br> $V_{\mathrm{CC} 1}=V_{\mathrm{RT} 1 / 2}$ or <br> $I_{\mathrm{FSO}}=200 \mu \mathrm{~A}$ for <br> $V_{\mathrm{CC} 1} \geq 1 \mathrm{~V}$ |
| Fail Safe high output <br> voltage | $V_{\mathrm{FS}}$ | $V_{\mathrm{CC}^{-}}$ <br> 0.6 | - | $V_{\mathrm{CC}}+$ <br> 0.1 | V | $I_{\mathrm{FSO}}=-1 \mathrm{~mA}$ for <br> $V_{\mathrm{CC} 1} \geq V_{\mathrm{RT} 1 / 2}$ |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

Sense Input (Early Warning) SI, $\boldsymbol{V}_{\mathbf{C C x}}$-Fail, Interrupt Output INT

| Sense In threshold voltage | $V_{\text {Sl,th }}$ | 1.8 | 2.3 | 2.8 | V | $V_{\text {SI }}$ decreasing |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 2.1 | 2.3 | 2.5 | V | measured at $25^{\circ} \mathrm{C}$, $V_{\mathrm{SI}}$ decreasing |
| Sense In threshold hysteresis | $V_{\text {Sl,hys }}$ | 100 | 200 | 300 | mV | - |
| Sense reaction time | $t_{\text {S, }}$ | 5 | 10 | 20 | $\mu \mathrm{S}$ | $\begin{aligned} & V_{\mathrm{SI}}<V_{\mathrm{SI}, \mathrm{th}} \text { to } \\ & \text { INT }=\text { low } \end{aligned}$ |
| Interrupt Out high voltage | $V_{\text {INThigh }}$ | $\begin{aligned} & 0.7 \times \\ & V_{\mathrm{CC} 1} \end{aligned}$ | - | $V_{\mathrm{CC} 1}$ | V | $I_{0}=-20 \mu \mathrm{~A}$ |
| Interrupt Out low voltage | $V_{\text {InTlow }}$ | 0 | - | 1.2 | V | $I_{0}=1.25 \mathrm{~mA}$ |
| Interrupt pull-up current | $I_{\text {INT }}$ | 20 | 150 | 500 | $\mu \mathrm{A}$ | $V_{\text {INT }}=0 \mathrm{~V}$ |
| Input voltage for Flash Programming Mode at pin INT | $V_{\text {INT }}$ | 7 | - | - | V |  |
| $V_{\mathrm{CC1}}$-Fail threshold voltage | $V_{\mathrm{Vcc} 1, \mathrm{th}}$ | 2.1 | 2.6 | 3.1 | V | - |
| $V_{\mathrm{CC1}}$-Fail reaction time | $t_{\mathrm{VcC1}, \mathrm{r}}$ | 10 | 20 | 30 | $\mu \mathrm{S}$ | - |

## Watchdog Generator

| Long open window <br> (128 cyl.) | $t_{\text {LW }}$ | 51 | 64 | 77 | ms | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Watchdog reset-pulse | $t_{\text {WDR1 }}$ | 3.6 | 5.0 | 6.0 | ms | default SPI setting |
|  | $t_{\text {WDR2 }}$ | 0.012 | 0.5 | 0.6 | ms | SPI setting option |
| Watchdog current <br> threshold | $I_{\text {WD,th }}$ | 0.5 | - | 8 | mA | - |

## Monitoring Inputs MONx

| MONx input threshold <br> voltage | $V_{\text {MONxth }}$ | 2 | 3 | 4 | V | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |
| Input hysteresis | $V_{\mathrm{l}, \text { hys. }}$ | 0.1 | - | 0.7 | V |  |
| Pull up current | $I_{\mathrm{PU}, \mathrm{MON}}$ | -30 | -10 | -3 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{MON}}=3.8 \mathrm{~V}$ |
| Pull down current | $I_{\mathrm{PD}, \mathrm{MON}}$ | 3 | 10 | 30 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{MON}}=2 \mathrm{~V}$ |
| MONx filter time | $t_{\mathrm{MONx}, \mathrm{f}}$ | 10 | - | 20 | $\mu \mathrm{~S}$ | - |
| Input current | $I_{\mathrm{MONx}}$ | -2 | - | 2 | $\mu \mathrm{~A}$ | $V_{\mathrm{MONx}}=0 \mathrm{~V} ;$ <br> $\mathrm{V}_{\mathrm{MONx}}>5 \mathrm{~V}$ |

## High Side Output OUTHS

| Static Drain-Source | $R_{\text {DSon HS }}$ | - | 2.5 | 3.5 | $\Omega$ | $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ON-Resistance; $I_{\text {OUTH }}=-150 \mathrm{~mA}$ |  | - | - | 6.0 | $\Omega$ | - |
| Active Zener voltage | $V_{\text {OUTHS }}$ | - | $V_{\mathrm{S}}-45$ | - | V | $I_{\text {OUTHS }}=-0.15 \mathrm{~A}$ |
| Leakage current | $I_{\text {QLHS }}$ | -10 | - | - | $\mu \mathrm{A}$ | $V_{\text {OUTHS }}=0 \mathrm{~V}$ |
| Switch ON delay time | $t_{\text {donHs }}$ | - | - | 20 | $\mu \mathrm{S}$ | CSN high to OUTHS |
| Switch OFF delay time | $t_{\text {dOFFHS }}$ | - | - | 20 | $\mu \mathrm{S}$ | CSN high to OUTHS |
| Overcurrent shutdown threshold | $I_{\text {SDHS }}$ | -0.8 | -0.4 | -0.2 | A | - |
| Shutdown filter time | $t_{\text {dSDHS }}$ | 10 | 25 | 40 | $\mu \mathrm{S}$ | - |
| UV-Switch-ON voltage | $V_{\text {UV ON }}$ | - | 5.35 | 6.00 | V | $V_{\text {S }}$ increasing |
| UV-Switch-OFF voltage | $V_{\text {UV OfF }}$ | 4.50 | 4.85 | - | V | $V_{\text {S }}$ decreasing |
| UV-ON/OFF-Hysteresis | $V_{\text {UV HY }}$ | 0.1 | 0.2 | - | V | $V_{\text {UV ON }}-V_{\text {UV OfF }}$ |
| Cyclic sense period | $t_{\text {P CS }}$ | - | $\begin{aligned} & 16 \text { to } \\ & 512 \end{aligned}$ | - | ms | selectable via SPI bits; tolerance depending on internal oscillator |
| Cyclic sense ON time | $t_{\text {CS on1 }}$ | 0.4 | 0.5 | 0.6 | ms | default SPI setting |
|  | $t_{\text {CS on2 }}$ | 0.08 | 0.1 | 0.12 | ms | SPI option |

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## Electrical Characteristics

## Table 13 Electrical Characteristics (cont'd)

$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  | Min. | Typ. |  |  |
|  |  |  |  |  |  |  |

## Send to Sleep Input (STS)

| H-input voltage <br> threshold | $V_{\mathrm{IH}}$ | - | - | $0.7 \times$ | V | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| L-input voltage <br> threshold | $V_{\mathrm{IL}}$ | $0.3 \times$ <br> $V_{\mathrm{CC} 1}$ | - | - | V | - |
| Hysteresis of input <br> voltage | $V_{\mathrm{IHY}}$ | 0.8 | - | 1.5 | V | - |
| Pull-down resistance at <br> pin STS | $R_{\mathrm{ISTS}}$ | 20 | 40 | 80 | $\mathrm{k} \Omega$ | $V_{\mathrm{STS}}=0.2 \times V_{\mathrm{CC} 1}$ |
| STS pulse width | $t_{\mathrm{STS}}$ | 10 | - | - | $\mu \mathrm{S}$ | one oscillator period |

## Wake Event Output WKO

| HIGH level output <br> voltage | $V_{\mathrm{WKO}, \mathrm{H}}$ | $0.8 \times$ <br> $V_{\mathrm{CC} 1}$ | - | - | V | $I_{\mathrm{WKO}}=-1.6 \mathrm{~mA}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LOW level output <br> voltage | $V_{\mathrm{WKO}, \mathrm{L}}$ | - | - | $0.2 \times$ <br> $V_{\mathrm{CC} 1}$ | V | $I_{\mathrm{WKO}}=1.6 \mathrm{~mA}$ |

CAN Transceiver Characteristics
Receiver Output RxD

| HIGH level output <br> current | $I_{\mathrm{RD}, \mathrm{H}}$ | - | -4 | -2 | mA | $V_{\mathrm{RD}}=0.8 \times V_{\mathrm{CC} 1} ;$ <br> $V_{\text {diff }}<0.4 \mathrm{~V}^{1)}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LOW level output <br> current | $I_{\mathrm{RD}, \mathrm{L}}$ | 2 | 4 | - | mA | $V_{\mathrm{RD}}=0.2 \times V_{\mathrm{CC} 1} ;$ <br> $V_{\text {diff }}>1 \mathrm{~V}^{11}$ |

## Transmission Input TxD

| HIGH level input voltage <br> threshold | $V_{\mathrm{TD}, \mathrm{H}}$ | - | $0.5 \times$ <br> $V_{\mathrm{CC} 1}$ | $0.7 \times$ <br> $V_{\mathrm{CC} 1}$ | V | recessive state |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| TxD input hysteresis | $V_{\mathrm{TD}, \mathrm{hys}}$ | - | 0.4 | - | V | - |
| LOW level input voltage <br> threshold | $V_{\mathrm{TD}, \mathrm{L}}$ | $0.3 \times$ <br> $V_{\mathrm{CC} 1}$ | $0.5 \times$ | - | V | dominant state |
| TxD pull-up resistance | $R_{\mathrm{TD}}$ | 10 | 20 | 40 | $\mathrm{k} \Omega$ | - |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  | Min. | Typ. | Max. |  |
|  |  |  |  |  |  |  |

CAN Bus Receiver

| Differential receiver <br> threshold voltage, <br> recessive to dominant <br> edge | $V_{\text {diff,d }}$ | - | 0.80 | 0.90 | V | $V_{\text {diff }}=V_{\text {CANH }}-V_{\text {CANL }}$ <br> "active mode" |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Differential receiver <br> threshold voltage, <br> dominant to recessive <br> edge | $V_{\text {diff,r }}$ | 0.50 | 0.60 | - | V | $V_{\text {diff }}=V_{\text {CANH }}-V_{\text {CANL }}$ <br> "active mode" |
| Common Mode Range | CMR | -12 | - | 12 | V | - |
| Differential receiver <br> hysteresis | $V_{\text {diff,hys }}$ | - | 110 | - | mV | "active mode" |
| CANH, CANL input <br> resistance | $R_{\mathrm{i}}$ | 10 | 20 | 30 | $\mathrm{k} \Omega$ | recessive state |
| Differential input <br> resistance | $R_{\text {diff }}$ | 20 | 40 | 60 | $\mathrm{k} \Omega$ | recessive state |
| Wake-up Receiver <br> threshold voltage, <br> recessive to dominant <br> edge | $V_{\text {diff, }}$ | - | 0.8 | 1.15 | V | "sleep/stop mode" |
| Wake-up Receiver <br> threshold voltage, <br> dominant to recessive <br> edge | $V_{\text {diff, } \mathrm{r}}$ | 0.4 | 0.7 | - | V | "sleep/stop mode" |
| Wake-up Receiver <br> differential receiver <br> hysteresis | $V_{\text {diff, hys. }}$ | - | 120 | - | mV | "sleep/stop mode" |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

CAN Bus Transmitter

| CANL/CANH recessive output voltage | $V_{\text {CANL/H }}$ | 2.0 | - | 3.0 | V | no load |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CANH, CANL recessive output voltage difference $V_{\text {diff }}=V_{\mathrm{CANH}}-V_{\mathrm{CANL}}$ | $V_{\text {diff }}$ | -500 | - | 50 | mV | $\begin{aligned} & V_{\mathrm{TXD}}=V_{\mathrm{CC} 1} ; \\ & \text { no load } \end{aligned}$ |
| CANL dominant output voltage | $V_{\text {CANL }}$ | 0.5 | - | 2.25 | V | $\begin{aligned} & V_{\mathrm{TXD}}=0 \mathrm{~V} ; \\ & V_{\mathrm{CC} 2}=5 \mathrm{~V} \end{aligned}$ |
| CANH dominant output voltage | $V_{\text {CANH }}$ | 2.75 | - | 4.5 | V | $\begin{aligned} & V_{\mathrm{TXD}}=0 \mathrm{~V} ; \\ & V_{\mathrm{CC} 2}=5 \mathrm{~V} \end{aligned}$ |
| CANH, CANL dominant output voltage difference $V_{\text {diff }}=V_{\text {CANH }}-V_{\text {CANL }}$ | $V_{\text {diff }}$ | 1.5 | - | 3.0 | V | $\begin{aligned} & V_{\mathrm{TXD}}=0 \mathrm{~V} ; \\ & V_{\mathrm{CC} 2}=5 \mathrm{~V} \end{aligned}$ |
| CANH short circuit current | $I_{\text {CANHsc }}$ | -200 | -80 | -50 | mA | $V_{\text {CANHshort }}=0 \mathrm{~V}$ |
| CANL short circuit current | $I_{\text {CANLsc }}$ | 50 | 80 | 200 | mA | $V_{\text {CANLshort }}=18 \mathrm{~V}$ |
| Leakage current | $I_{\text {CANH,lk }}$ <br> $I_{\text {CANL, Ik }}$ | - | 25 | - | $\mu \mathrm{A}$ | $\begin{aligned} & V_{\mathrm{S}}=V_{\mathrm{CC} 2}=0 \mathrm{~V} ; \\ & 0 \mathrm{~V}<V_{\mathrm{CANH}, \mathrm{~L}}<5 \mathrm{~V} \end{aligned}$ |

## Split Termination Output; Pin SPLIT

| Split output voltage | $V_{\text {SPLIT }}$ | $0.3 \times$ <br> $V_{\mathrm{CC} 2}$ | $0.5 \times$ <br> $V_{\mathrm{CC} 2}$ | $0.7 \times$ <br> $V_{\mathrm{CC} 2}$ | V | normal mode; <br> $-500 \mu \mathrm{~A}<I_{\mathrm{SPLIT}}<$ <br> $500 \mu \mathrm{~A}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Leakage current | $I_{\text {SPLIT }}$ | -5 | 0 | 5 | $\mu \mathrm{~A}$ | standby mode; <br> $-22 \mathrm{~V}<V_{\text {SPLIT }}<35 \mathrm{~V}$ |
| SPLIT output resistance | $R_{\mathrm{SPLIT}}$ | - | 600 | - | $\Omega$ | - |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

## Dynamic CAN-Transceiver Characteristics

$\left.\begin{array}{l|l|l|l|l|l|l}\hline \begin{array}{l}\text { Propagation delay } \\ \text { TxD-to-RxD LOW } \\ \text { (recessive to dominant) }\end{array} & t_{\mathrm{d}(\mathrm{L}), \mathrm{TR}} & - & 150 & 255 & \mathrm{~ns} & \begin{array}{l}C_{\mathrm{L}}=47 \mathrm{pF} ; \\ R_{\mathrm{L}}=60 \Omega ; \\ V_{\mathrm{CC} 1 / 2}=5 \mathrm{~V} ;\end{array} \\ C_{\mathrm{RxD}}=20 \mathrm{pF}\end{array}\right]$

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

LIN Transceiver Characteristics
Receive Output RxD

| HIGH level output <br> voltage | $V_{\mathrm{RXD}, \mathrm{H}}$ | $0.8 \times$ <br> $V_{\mathrm{CC} 1}$ | - | - | V | $I_{\mathrm{RXD}(\mathrm{LIN})}=-1.6 \mathrm{~mA} ;$ <br> $V_{\mathrm{bus}}=V_{\mathrm{S}}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LOW level output <br> voltage | $V_{\mathrm{RxD}, \mathrm{L}}$ | - | - | $0.2 \times$ | V | $I_{\mathrm{RXD}(\mathrm{LIN})}=1.6 \mathrm{~mA} ;$ <br> $V_{\mathrm{bus}}=0 \mathrm{~V}$ |

Transmission Input TxD
$\left.\begin{array}{l|l|l|l|l|l|l}\hline \begin{array}{l}\text { HIGH level input voltage } \\ \text { threshold }\end{array} & V_{\mathrm{TXD}, \mathrm{H}} & - & - & 0.7 \times & \mathrm{V} & \text { recessive state } \\ V_{\mathrm{CC} 1}\end{array}\right)$

## Bus Receiver

| Receiver threshold <br> voltage, recessive to <br> dominant edge | $V_{\text {bus,rd }}$ | 0.42 <br> $\times V_{\mathrm{S}}$ | $0.48 \times$ <br> $V_{\mathrm{S}}$ | - | V | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Receiver dominant <br> state | $V_{\text {busdom }}$ | - | - | 0.40 <br> $\times V_{\mathrm{S}}$ | V | (LIN Spec 1.3 (2.0); <br> Line 10.1.9 (3.1.9)) |
| Receiver threshold <br> voltage, dominant to <br> recessive edge | $V_{\text {bus,dr }}$ | - | $0.52 \times$ <br> $V_{\mathrm{S}}$ | 0.58 <br> $\times V_{\mathrm{S}}$ | V | $V_{\text {bus,rec }}<V_{\text {bus }}<27 \mathrm{~V}$ |
| Receiver recessive <br> state | $V_{\text {busrec }}$ | $0.6 \times$ <br> $V_{\mathrm{S}}$ | - | - | - | (LIN Spec 1.3 (2.0); <br> Line 10.1.10 (3.1.10)) |
| Receiver center voltage | $V_{\text {buscent }}$ | 0.475 <br> $\times V_{\mathrm{S}}$ | $0.5 \times$ <br> $V_{\mathrm{S}}$ | 0.525 <br> $\times V_{\mathrm{S}}$ | V | (LIN Spec 1.3 (2.0); <br> Line 10.1.11 (3.1.11)) |
| Receiver hysteresis | $V_{\text {bus,hys }}$ | 0.02 <br> $\times V_{\mathrm{S}}$ |  | 0.175 <br> $\times V_{\mathrm{S}}$ | V | $V_{\text {bus,hys }}=$ <br> $V_{\text {bus,rec }}-V_{\text {bus,dom }}$ <br> $($ LIN Spec 1.3 (2.0); |
| Line 10.1.12 (3.1.12)) |  |  |  |  |  |  |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |
| Wake-up threshold | $V_{\text {wake }}$ | 0.40 | $0.5 \times$ | $0.6 \times$ | V | - |
| voltage |  | $\times V_{\mathrm{S}}$ | $V_{\mathrm{S}}$ | $V_{\mathrm{S}}$ |  |  |

## Bus Transmitter

| Bus serial diode voltage drop | $V_{\text {serdiode }}$ | 0.4 | 0.7 | 1.0 | V | $V_{\text {TxD }}=$ high Level |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Bus dominant output voltage | $V_{\text {bus,dom }}$ | - | - | 1.2 | V | $\begin{aligned} & V_{\mathrm{TXD}}=0 \mathrm{~V} ; V_{\mathrm{S}}=7 \mathrm{~V} ; \\ & R_{\mathrm{L}}=500 \Omega ; \\ & \text { (LIN Spec 1.3; } \\ & \text { Line 10.1.13) } \end{aligned}$ |
|  |  | - | - | 2.0 | V | $\begin{aligned} & V_{\mathrm{S}}=18 \mathrm{~V} ; \\ & R_{\mathrm{L}}=500 \Omega ; \end{aligned}$ <br> (LIN Spec 1.3; Line 10.1.14) |
| Bus dominant output voltage | $V_{\text {bus,dom }}$ | 0.6 | - | - | V | $\begin{aligned} & V_{\mathrm{TXD}}=0 \mathrm{~V} ; V_{\mathrm{S}}=7 \mathrm{~V} ; \\ & R_{\mathrm{L}}=1 \mathrm{k} \Omega ; \end{aligned}$ <br> (LIN Spec 1.3; Line 10.1.15) |
|  |  | 0.8 | - | - | V | $V_{\mathrm{S}}=18 \mathrm{~V} ; R_{\mathrm{L}}=1 \mathrm{k} \Omega ;$ <br> (LIN Spec 1.3; Line 10.1.16) |
| Bus short circuit current | $I_{\text {bus,sc }}$ | 40 | 100 | 150 | mA | $V_{\text {bus,short }}=18 \mathrm{~V}$ <br> (LIN Spec 1.3 (2.0); <br> Line 10.1.4 (3.1.4)) |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Leakage current | $I_{\mathrm{bus}, \mathrm{k}}$ | -1000 | - | - | $\mu \mathrm{A}$ | $V_{\mathrm{s}}=0 \mathrm{~V} ; V_{\text {bus }}=-12 \mathrm{~V}$ <br> (LIN Spec 1.3 (2.0); <br> Line 10.1.7 (3.1.7)) |
|  |  | -500 | -140 |  | $\mu \mathrm{A}$ | $V_{\mathrm{S}}=0 \mathrm{~V} ; V_{\text {bus }}=-8 \mathrm{~V}$ |
|  |  | - | 10 | 25 | $\mu \mathrm{A}$ | $V_{\mathrm{S}}=0 \mathrm{~V} ; V_{\text {bus }}=18 \mathrm{~V}$ <br> (LIN Spec 1.3 (2.0); <br> Line 10.1.8 (3.1.8)) |
|  |  | -1 | - | - | mA | $V_{\mathrm{s}}=18 \mathrm{~V} ; V_{\mathrm{bus}}=0 \mathrm{~V}$ <br> (LIN Spec 1.3 (2.0); <br> Line 10.1.5(3.1.5)) |
|  |  | - | - | 20 | $\mu \mathrm{A}$ | $V_{\mathrm{BUS}}=18 \mathrm{~V} V_{\mathrm{S}}=8 \mathrm{~V}$ <br> (LIN Spec 1.3 (2.0); <br> Line 10.1.6 (3.1.6)) |
| Bus pull-up resistance | $R_{\text {bus }}$ | 20 | 30 | 60 | $\mathrm{k} \Omega$ | Active/Standby mode (LIN Spec 1.3 (2.0); Line 10.2.2 (3.2.2)) |
| LIN output current | $I_{\text {lin }}$ | 5 | 20 | 60 | $\mu \mathrm{A}$ | Sleep mode; $V_{\text {bus }}=0 \mathrm{~V}$ |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

## Dynamic Transceiver Characteristics

| Slew rate falling edge | $S_{\text {fslope }}$ | -3 | - | -1 | V/ $/ \mathrm{S}$ | $\begin{aligned} & 60 \%>V_{\text {bus }}>40 \% \\ & 1 \mu \mathrm{~s}<\left(\tau=R_{\mid} \times C_{\text {bus }}\right) \\ & <5 \mu \mathrm{~s} ; \\ & V_{\mathrm{S}}=18 \mathrm{~V} ; \\ & \text { Active mode }{ }^{2)} \\ & (\text { LIN Spec 1.3; } \\ & \text { Line 10.3.1) } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Slew rate falling edge | $S_{\text {fslope }}$ | -3 | - | -0.5 | $\mathrm{V} / \mu \mathrm{S}$ | $\begin{aligned} & 60 \%>V_{\text {bus }}>40 \% \\ & 1 \mu \mathrm{~s}<\left(\tau=R_{\mathrm{l}} \times C_{\text {bus }}\right) \\ & <5 \mu \mathrm{~s} ; \\ & V_{\mathrm{S}}=7 \mathrm{~V} ; \\ & \text { Active mode }{ }^{2)} \\ & \text { (LIN Spec 1.3; } \\ & \text { Line 10.3.2) } \end{aligned}$ |
| Slew rate rising edge | $S_{\text {rslope }}$ | 1 | - | 3 | $\mathrm{V} / \mu \mathrm{S}$ | $\begin{aligned} & 40 \%<V_{\text {bus }}<60 \% \\ & 1 \mu \mathrm{~s}<\left(\tau=R_{\mid} \times C_{\text {bus }}\right) \\ & <5 \mu \mathrm{~s} ; \\ & V_{\mathrm{S}}=18 \mathrm{~V} ; \\ & \text { Active mode }{ }^{2)} \\ & \text { (LIN Spec 1.3; } \\ & \text { Line 10.3.1) } \end{aligned}$ |
| Slew rate rising edge | $S_{\text {rslope }}$ | 0.5 | - | 3 | $\mathrm{V} / \mu \mathrm{S}$ | $\begin{aligned} & 40 \%<V_{\text {bus }}<60 \% \\ & 1 \mu \mathrm{~s}<\left(\tau=R_{\mid} \times C_{\text {bus }}\right) \\ & <5 \mu \mathrm{~s} ; \\ & V_{\mathrm{S}}=7 \mathrm{~V} ; \\ & \text { Active mode. }{ }^{2)} \\ & \text { (LIN Spec 1.3; } \\ & \text { Line 10.3.2) } \end{aligned}$ |
| Slope symmetry | $t_{\text {slopesym }}$ | -5 | - | 5 | $\mu \mathrm{S}$ | $\begin{aligned} & t_{\text {fslope }}-t_{\text {rslope }} ; \\ & V_{\mathrm{S}}=18.0 \mathrm{~V}^{2)} \end{aligned}$ <br> (LIN Spec 1.3; <br> Line 10.3.3) |

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## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Propagation delay TxD LOW to bus | $t_{\mathrm{d}(\mathrm{L}), \mathrm{T}}$ | - | 1 | 4 | $\mu \mathrm{S}$ | (LIN Spec 1.3; Line 10.3.6) ${ }^{2)}$ |
| Propagation delay TxD HIGH to bus | $t_{\text {d(H), }{ }^{\text {T }} \text { }}$ | - | 1 | 4 | $\mu \mathrm{S}$ | (LIN Spec 1.3; Line 10.3.6) ${ }^{2)}$ |
| Propagation delay bus dominant to RxD LOW | $t_{\mathrm{d}(\mathrm{L}), \mathrm{R}}$ | - | 1 | 6 | $\mu \mathrm{S}$ | $C_{\mathrm{R} \times \mathrm{D}}=20 \mathrm{pF}$ <br> (LIN Spec 1.3; <br> Line 10.3.7) |
| Propagation delay bus recessive to RxD HIGH | $t_{\text {d(H),R }}$ | - | 1 | 6 | $\mu \mathrm{S}$ | $C_{\mathrm{RXD}}=20 \mathrm{pF} ;$ <br> (LIN Spec 1.3; <br> Line 10.3.7) |
| Receiver delay symmetry | $t_{\text {sym, }}$ | -2 | - | 2 | $\mu \mathrm{S}$ | $t_{\text {sym,R }}=t_{\mathrm{d}(\mathrm{~L}), \mathrm{R}}-t_{\mathrm{d}(\mathrm{H}), \mathrm{R}}$ <br> (LIN Spec 1.3; <br> Line 10.3.8) |
| Transmitter delay symmetry | $t_{\text {sym, }, ~}$ | -2 | - | 2 | $\mu \mathrm{S}$ | $t_{\mathrm{sym}, \mathrm{~T}}=t_{\mathrm{d}(\mathrm{~L}), \mathrm{T}}-t_{\mathrm{d}(\mathrm{H}), \mathrm{T}}$ <br> (LIN Spec 1.3; Line 10.3.9) ${ }^{2)}$ |
| Wake-up delay time | $t_{\text {wake }}$ | 30 | 100 | 150 | $\mu \mathrm{S}$ | $T_{\mathrm{j}} \leq 125^{\circ} \mathrm{C}$ |
|  |  | - | - | 170 | $\mu \mathrm{s}$ | $T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ |
| TxD dominant time out | $t_{\text {timeout }}$ | 6 | 12 | 20 | ms | $V_{\text {TXD }}=0 \mathrm{~V}$ |
| TxD dominant time out recovery time | $t_{\text {torec }}$ | - | 10 | - | $\mu \mathrm{S}$ | $V_{\mathrm{TXD}}=5 \mathrm{~V}$ <br> Not subject to production test. Specified by design |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  | Min. |  | Max. |  |

Transfer Rate $20 \mathrm{kBit} / \mathrm{s}$; $1 \mu \mathrm{~s}<\tau=\boldsymbol{R}_{\mathrm{L}} \times \boldsymbol{C}_{\mathrm{bus}}<5 \mu \mathrm{~s}$

| Duty cycle D1 | D1 | 0.396 | - | - | duty cycle 1: <br> $\mathrm{TH}_{\mathrm{Rec}(\text { max })}=$ $0.744 \times V_{\mathrm{S}}$; <br> $\mathrm{TH}_{\text {Dom(max) }}=$ $0.581 \times V_{\mathrm{S}}$; $V_{\mathrm{S}}=7.0 \ldots 18 \mathrm{~V}$; $t_{\text {bit }}=50 \mu \mathrm{~s}$; D1 $=t_{\text {bus_rec(min) }} /\left[2 t_{\text {bit }}\right]$ (LIN Spec 2.0; line 3.3.1) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Duty cycle D2 | D2 | - | - | 0.581 | duty cycle 2 : $\begin{aligned} & \mathrm{TH}_{\text {Rec(min) }}= \\ & 0.422 \times V_{\mathrm{S}} ; \\ & \mathrm{TH}_{\text {Dom(min) }}= \\ & 0.284 \times V_{\mathrm{S}} ; \\ & V_{\mathrm{S}}=7.6 \ldots 18 \mathrm{~V} ; \\ & t_{\text {bit }}=50 \mu \mathrm{~s} ; \\ & \left.\mathrm{D} 2=t_{\text {bus }} \text { rec(max) }\right) \\ & (\mathrm{LIN} \mathrm{Spec} 2.0 ; \\ & \text { line } 3.3 .2) \end{aligned}$ |

Transfer Rate 10.4 kBit/s; $1 \mu \mathrm{~s}<\tau=\boldsymbol{R}_{\mathrm{L}} \times \boldsymbol{C}_{\mathrm{bus}}<5 \mu \mathrm{~s}$

| Duty cycle D3 | D3 | 0.417 | - | - | duty cycle 3 <br> $\mathrm{TH}_{\text {Rec (max) }}=$ $0.778 \times V_{\mathrm{S}}$; <br> $\mathrm{TH}_{\text {Dom(max) }}=$ $0.616 \times V_{\mathrm{S}}$; $V_{\mathrm{S}}=7.0 \ldots 18 \mathrm{~V}$; $t_{\text {bit }}=96 \mu \mathrm{~s}$; D3 $=t_{\text {bus_rec(min) }} /\left[2 t_{\text {bit }}\right]$ (LIN Spec 2.0; line 3.4.1) |
| :---: | :---: | :---: | :---: | :---: | :---: |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Duty cycle D4 | D4 | - | - | 0.590 |  | duty cycle 4 $\begin{aligned} & \mathrm{TH}_{\text {Rec(min) }}= \\ & 0.389 \times V_{\mathrm{S}} ; \\ & \mathrm{TH}_{\text {Dom(min) }}= \\ & 0.251 \times V_{\mathrm{S}} ; \\ & V_{\mathrm{S}}=7.6 \ldots 18 \mathrm{~V} ; \\ & t_{\text {bit }}=96 \mu \mathrm{~s} ; \\ & \mathrm{D} 4=t_{\text {bus rec(max) })}\left[2 t_{\text {bit }}\right] \\ & (\mathrm{LIN} \text { Spec } 2.0 ; \end{aligned}$ line 3.4.2) |

## Master Termination Switch Output; Pin MTS

| Ron resistance | $R_{\text {onMTS }}$ | - | 33 | 60 | $\Omega$ | $I_{\text {MTS }}=-15 \mathrm{~mA}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Maximum output <br> current | $I_{\text {MTS }}$ | 40 | - | 150 | mA | $V_{\text {MTS }}=0 \mathrm{~V}$ |
| Leakage current | $I_{\text {MTS }, \mathrm{k}}$ | -5.0 | - | 5.0 | $\mu \mathrm{~A}$ | sleep mode; <br> $V_{\text {MTS }}=0 \mathrm{~V}$ |

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Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  | Unit | Test Condition |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |

## SPI-Interface

## Logic Inputs DI, CLK and CSN

| H-input voltage <br> threshold | $V_{\mathrm{IH}}$ | - | - | $0.7 \times$ <br> $V_{\mathrm{CC} 1}$ | V | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| L-input voltage <br> threshold | $V_{\mathrm{IL}}$ | $0.3 \times$ <br> $V_{\mathrm{CC} 1}$ | - | - | V | - |
| Hysteresis of input <br> voltage | $V_{\mathrm{IHY}}$ | 0.8 |  | 1.5 | V | - |
| Pull-up resistance at pin <br> CSN | $R_{\mathrm{ICSN}}$ | 20 | 40 | 80 | $\mathrm{k} \Omega$ | $V_{\mathrm{CSN}}=0.7 \times V_{\mathrm{CC} 1}$ |
| Pull-down resistance at <br> pin DI and CLK | $R_{\mathrm{ICLK} / \mathrm{DI}}$ | 20 | 40 | 80 | $\mathrm{k} \Omega$ | $V_{\mathrm{DI/CLK}}=0.2 \times V_{\mathrm{CC} 1}$ |
| Input capacitance <br> at pin CSN, DI or CLK | $C_{\mathrm{I}}$ | - | 10 | 15 | pF | Not subject to production <br> test. Specified by design |

## Logic Output DO

| H-output voltage level | $V_{\mathrm{DOH}}$ | $V_{\mathrm{CC} 1}$ <br> -0.4 | $V_{\mathrm{CC} 1}-$ <br> 0.2 | - | V | $I_{\mathrm{DOH}}=-1 \mathrm{~mA}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| L-output voltage level | $V_{\mathrm{DOL}}$ | - | 0.2 | 0.4 | V | $I_{\mathrm{DOL}}=1.6 \mathrm{~mA}$ |
| Tri-state leakage <br> current | $I_{\mathrm{DOLK}}$ | -10 | - | 10 | $\mu \mathrm{~A}$ | $V_{\mathrm{CSN}}=V_{\mathrm{CC} 1} ;$ <br> $0 \mathrm{~V}<V_{\mathrm{DO}}<V_{\mathrm{CC} 1}$ |
| Tri-state input <br> capacitance | $C_{\mathrm{DO}}$ | - | 10 | 15 | pF | Not subject to production <br> test. Specified by design |

Data Input Timing Not subject to production test. Specified by design

| Clock period | $t_{\text {pCLK }}$ | 250 | - | - | ns | - |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Clock high time | $t_{\text {CLKH }}$ | 125 | - | - | ns | - |
| Clock low time | $t_{\text {CLKL }}$ | 125 | - | - | ns | - |
| Clock low before CSN <br> low | $t_{\text {bef }}$ | 125 | - | - | ns | - |
| CSN setup time | $t_{\text {lead }}$ | 250 | - | - | ns | - |

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Electrical Characteristics

## Table 13 Electrical Characteristics (cont'd)

$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40^{\circ} \mathrm{C}<T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| CLK setup time | $t_{\text {lag }}$ | 250 | - | - | ns | - |
| Clock low after CSN high | $t_{\text {beh }}$ | 125 | - | - | ns | - |
| DI setup time | $t_{\text {DISU }}$ | 50 | - | - | ns | - |
| DI hold time | $t_{\text {DIHO }}$ | 50 | - | - | ns | - |
| Input signal rise time at pin DI, CLK and CSN | $t_{\text {riN }}$ | - | - | 50 | ns | - |
| Input signal fall time at pin DI, CLK and CSN | $t_{\text {fin }}$ | - | - | 50 | ns | - |
| Delay time for mode change from Normal Mode to Sleep Mode | $t_{\text {fiN }}$ | - | - | 10 | $\mu \mathrm{S}$ | - |
| CSN high time | $t_{\text {CSN(high })}$ | 15 | - | - | $\mu \mathrm{S}$ | two oscillator periods |

Data Output Timing Not subject to production test. Specified by design

| DO rise time | $t_{\mathrm{rDO}}$ | - | 30 | 80 | ns | $C_{\mathrm{L}}=100 \mathrm{pF}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| DO fall time | $t_{\text {fDO }}$ | - | 30 | 80 | ns | $C_{\mathrm{L}}=100 \mathrm{pF}$ |
| DO enable time | $t_{\text {ENDO }}$ | - | - | 50 | ns | low impedance |
| DO disable time | $t_{\text {DISDO }}$ | - | - | 50 | ns | high impedance |

## Thermal Prewarning and Shutdown (junction temperatures)

(Not subject to production test. Specified by design)

| $V_{\mathrm{CC} 1}$ thermal <br> prewarning <br> ON temperature | $T_{\mathrm{jPW}}$ | 120 | 145 | 170 | ${ }^{\circ} \mathrm{C}$ | bit 0 of SPI diagnosis <br> word |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $V_{\mathrm{CC} 1}$ thermal <br> prewarning hyst. | $\Delta T$ | - | 25 | - | K | - |
| $V_{\mathrm{CC} 1 / 2}$ thermal <br> shutdown temp. | $T_{\mathrm{jSD}}$ | 155 | 185 | 200 | ${ }^{\circ} \mathrm{C}$ | hysteresis 35 K (typ.) |
| $V_{\mathrm{CC} 1}$ ratio of SD to PW <br> temp. | $T_{\mathrm{jSD}} /$ <br> $T_{\mathrm{jPW}}$ | - | 1.20 | - | - | - |

## Electrical Characteristics

Table 13 Electrical Characteristics (cont'd)
$V_{\mathrm{S}}=13.5 \mathrm{~V} ; I_{\mathrm{CC} 1}=1 \mathrm{~mA} ; 4.9 \mathrm{~V}<V_{\mathrm{CC} 1 / 2}<5.1 \mathrm{~V}$; SBC Active Mode; all outputs open; $-40{ }^{\circ} \mathrm{C}<T_{\mathrm{j}}<150{ }^{\circ} \mathrm{C}$ (max. $125{ }^{\circ} \mathrm{C}$ for CAN circuit characteristics); all voltages with respect to ground; positive current defined flowing into pin; unless otherwise specified.

| Parameter | Symbol | Limit Values |  |  | Unit | Test Condition |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |
| OUTHS thermal <br> shutdown temp. | $T_{\text {jSD }}$ | 150 | 175 | 200 | ${ }^{\circ} \mathrm{C}$ | - |
| OUTHS thermal <br> shutdown hyst. | $\Delta T$ | - | 10 | - | K | - |
| CAN Transmitter <br> thermal shutdown temp. | $T_{\text {jSD }}$ | 150 | - | 190 | ${ }^{\circ} \mathrm{C}$ | - |
| CAN Transmitter <br> thermal shutdown hyst. | $\Delta T$ | - | 10 | - | K | - |
| LIN Transmitter thermal <br> shutdown temp. | $T_{\mathrm{jSD}}$ | 150 | - | 190 | ${ }^{\circ} \mathrm{C}$ | - |
| LIN Transmitter thermal <br> shutdown hyst. | $\Delta T$ | - | 10 | - | K | - |

1) $V_{\text {diff }}=V_{\text {CANH }}-V_{\text {CANL }}$
2) tested at $20 \mathrm{kbit} / \mathrm{s}$

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Electrical Characteristics

## Timing Diagrams



Figure 12 SPI-Data Transfer Timing

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Electrical Characteristics


Figure 13 SPI-Input Timing


Figure 14 Turn OFFION Time

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Figure 15 DO Valid Data Delay Time and Valid Time


Figure 16 DO Enable and Disable Time

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$\mathrm{t}_{\text {wwRP }}$ : Window Watchdog Reset Period set via SPI, see table 9

Figure 17 Watchdog Time-Out Definitions


Figure 18 Watchdog Timing Diagram

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Figure 19 Reset Timing Diagram

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Electrical Characteristics


Figure 20 CAN Dynamic Characteristics Timing Diagram

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Figure 21 LIN Dynamic Characteristics Timing Diagram

Application Information

## 7 Application Information

### 7.1 ESD Tests

Tests for ESD robustness according to IEC61000-4-2 "gun test" (150pF, 330 ) have been performed. The results and test condition are available in a test report.

## Table 14 ESD "GUN test"

| Performed Test | Result | Unit | Remarks |
| :--- | :--- | :--- | :--- |
| ESD at pin CANH, CANL, LIN, Vs <br> versus GND | $\geq+8$ | kV | ${ }^{1)}$ Positive pulse |
| ESD at pin CANH, CANL, LIN, Vs <br> versus GND | $\leq-8$ | kV | ${ }^{1)}$ Negative pulse |

1) ESD susceptibility "ESD GUN" according LIN EMC 1.3 Test Specification, Section 4.3. (IEC 61000-4-2) Tested by external test house (IBEE Zwickau, EMC Test report Nr. 11-11-06).

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Application Information

### 7.2 Application Example



Figure 22 Application Circuit

## Package Outlines

## 8 Package Outlines



## Bottom View



Index Marking

1) Does not include plastic or metal protrusion of 0.15 max. per side
2) Does not include dambar protrusion of 0.05 max. per side
3) Distance from leads bottom (= seating plane) to exposed diepad

PG-DSO-36-24, -38, -41, -42, -50, -51, -53, -75, -77, -79-PO V09
Figure 23 PG-DSO-36-53 (Plastic Dual Small Outline with Exposed Pad)

## Green Product (RoHS Compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020)

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/packages. Dimensions in mm

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Revision History

## 9 Revision History

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| Revision History: 2013-12-05 |  |
| :--- | :--- |
| Previous Version: $\quad$ Revision 1.70 |  |
| Page | Subjects (major changes since last revision) |
| 2 | New package type: PG-DSO-36-53. |
| Previous Version: $\quad$ Revision 1.51 |  |
| Page | Subjects (major changes since last revision) |
| 2 | LIN compatibility to LIN 2.1 and SAE J2602-2 added. |
| 35 | Added additional line for Sense In threshold voltage, measured at 25${ }^{\circ} \mathrm{C}$ |
| 41 | Receiver Hysteresis: Parameter changed to specification of LIN 1.3 |
| 43 | LIN Leakage Current (first line): Test condition and parameter added <br> according to specification of LIN1.3, 2.0 and LIN2.1 |
| 44 | Slope Symmetry: Test condition updated to specification LIN1.3. |
| 44 | Slew Rate Falling Edge: Test condition changed to specification LIN1.3 |
| 44 | Slew Rate Rising Edge: Test condition changed to specification LIN1.3 |
| 45 | Propagation Delay: Test condition changed, tested at 20kbit/s according <br> LIN1.3 |
| 45 | Transmitter Delay Symmetry: Test condition changed, tested at 20kbit/s <br> according LIN1.3 |
| 46 | Slew Rate Rising and Falling Edge: Parameters for 10.4kBit/s removed |
| 60 | Figure 23: Update of Package Outlines drawing with reduced max. stand- <br> off |

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Revision History

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Revision History

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[^0]:    1) In Sleep Mode the Vcc2 should be switched off. This is the default setting at the SPI
